

# STARPOWER

SEMICONDUCTOR

**IGBT**

## GD600HTA120P6HT

**1200V/600A 6 in one-package**

### General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as hybrid and electric vehicle.

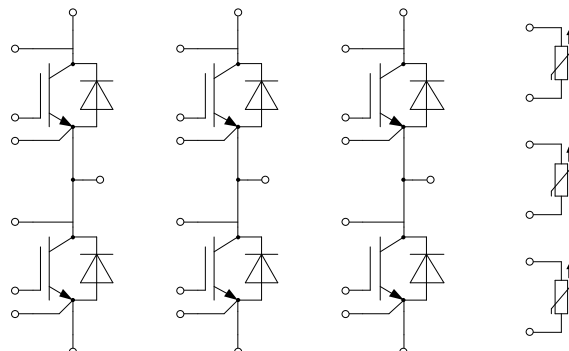
### Features

- Low  $V_{CE(sat)}$  Trench IGBT technology
- Low switching losses
- 6 $\mu$ s short circuit capability
- $V_{CE(sat)}$  with positive temperature coefficient
- Maximum junction temperature 175°C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper pinfin baseplate using Si<sub>3</sub>N<sub>4</sub>AMB technology

### Typical Applications

- Automotive application
- Hybrid and electric vehicle
- Inverter for motor drive

### Equivalent Circuit Schematic



**Absolute Maximum Ratings**  $T_F=25^{\circ}\text{C}$  unless otherwise noted**IGBT**

Symbol	Description	Values	Unit
$V_{CES}$	Collector-Emitter Voltage	1200	V
$V_{GES}$	Gate-Emitter Voltage	$\pm 20$	V
$I_{CN}$	Implemented Collector Current	600	A
$I_C$	Collector Current @ $T_F=90^{\circ}\text{C}$	450	A
$I_{CM}$	Pulsed Collector Current $t_p=1\text{ms}$	1200	A
$P_D$	Maximum Power Dissipation @ $T_F=75^{\circ}\text{C}$ $T_j=175^{\circ}\text{C}$	1075	W

**Diode**

Symbol	Description	Values	Unit
$V_{RRM}$	Repetitive Peak Reverse Voltage	1200	V
$I_{FN}$	Implemented Collector Current	600	A
$I_F$	Diode Continuous Forward Current	450	A
$I_{FM}$	Diode Maximum Forward Current $t_p=1\text{ms}$	1200	A

**Module**

Symbol	Description	Value	Unit
$T_{jmax}$	Maximum Junction Temperature	175	$^{\circ}\text{C}$
$T_{jop}$	Operating Junction Temperature continuous For 10s within a period of 30s, occurrence maximum 3000 times over lifetime	-40 to +150 +150 to +175	$^{\circ}\text{C}$
$T_{STG}$	Storage Temperature Range	-40 to +125	$^{\circ}\text{C}$
$V_{ISO}$	Isolation Voltage RMS, $f=50\text{Hz}$ , $t=1\text{min}$	2500	V
$d_{Creep}$	Terminal to Heatsink Terminal to Terminal	9.0 9.0	mm
$d_{Clear}$	Terminal to Heatsink Terminal to Terminal	4.5 4.5	mm

**IGBT Characteristics**  $T_F=25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit	
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=450\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$		1.40		V	
		$I_C=450\text{A}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}$		1.65			
		$I_C=450\text{A}, V_{GE}=15\text{V}, T_j=175^\circ\text{C}$		1.70			
		$I_C=600\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$		1.60			
		$I_C=600\text{A}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}$		1.90			
		$I_C=600\text{A}, V_{GE}=15\text{V}, T_j=175^\circ\text{C}$		2.00			
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=15.6\text{mA}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$		6.4		V	
$I_{CES}$	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$			1.0	mA	
$I_{GES}$	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$			400	nA	
$R_{Gint}$	Internal Gate Resistance			1.67		$\Omega$	
$C_{ies}$	Input Capacitance			81.2		nF	
$C_{oes}$	Output Capacitance	$V_{CE}=25\text{V}, f=100\text{kHz}, V_{GE}=0\text{V}$		1.56		nF	
$C_{res}$	Reverse Transfer Capacitance			0.53		nF	
$Q_G$	Gate Charge	$V_{CE}=600\text{V}, I_C=600\text{A}, V_{GE}=-8\dots+15\text{V}$		5.34		$\mu\text{C}$	
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=600\text{A}, R_{Gon}=1.0\Omega, R_{Goff}=2.2\Omega, L_S=22\text{nH}, V_{GE}=-8\text{V}/+15\text{V}, T_j=25^\circ\text{C}$		290		ns	
$t_r$	Rise Time			81		ns	
$t_{d(off)}$	Turn-Off Delay Time			895		ns	
$t_f$	Fall Time			87		ns	
$E_{on}$	Turn-On Switching Loss			53.5		mJ	
$E_{off}$	Turn-Off Switching Loss			47.5		mJ	
$t_{d(on)}$	Turn-On Delay Time		$V_{CC}=600\text{V}, I_C=600\text{A}, R_{Gon}=1.0\Omega, R_{Goff}=2.2\Omega, L_S=22\text{nH}, V_{GE}=-8\text{V}/+15\text{V}, T_j=150^\circ\text{C}$		322		ns
$t_r$	Rise Time				103		ns
$t_{d(off)}$	Turn-Off Delay Time				1017		ns
$t_f$	Fall Time				171		ns
$E_{on}$	Turn-On Switching Loss			84.2		mJ	
$E_{off}$	Turn-Off Switching Loss			63.7		mJ	
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600\text{V}, I_C=600\text{A}, R_{Gon}=1.0\Omega, R_{Goff}=2.2\Omega, L_S=22\text{nH}, V_{GE}=-8\text{V}/+15\text{V}, T_j=175^\circ\text{C}$			334		ns
$t_r$	Rise Time				104		ns
$t_{d(off)}$	Turn-Off Delay Time				1048		ns
$t_f$	Fall Time				187		ns
$E_{on}$	Turn-On Switching Loss			89.8		mJ	
$E_{off}$	Turn-Off Switching Loss			65.4		mJ	
$I_{SC}$	SC Data		$t_p \leq 6\mu\text{s}, V_{GE}=15\text{V}$		2000		A

$T_j=175^{\circ}\text{C}, V_{CC}=800\text{V},$ $V_{CEM}\leq 1200\text{V}$
--

### Diode Characteristics $T_f=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_F$	Diode Forward Voltage	$I_F=450\text{A}, V_{GE}=0\text{V}, T_j=25^{\circ}\text{C}$		1.80		V
		$I_F=450\text{A}, V_{GE}=0\text{V}, T_j=150^{\circ}\text{C}$		1.75		
		$I_F=450\text{A}, V_{GE}=0\text{V}, T_j=175^{\circ}\text{C}$		1.70		
		$I_F=600\text{A}, V_{GE}=0\text{V}, T_j=25^{\circ}\text{C}$		1.95		
		$I_F=600\text{A}, V_{GE}=0\text{V}, T_j=150^{\circ}\text{C}$		1.95		
		$I_F=600\text{A}, V_{GE}=0\text{V}, T_j=175^{\circ}\text{C}$		1.90		
$Q_r$	Recovered Charge			22.5		$\mu\text{C}$
$I_{RM}$	Peak Reverse Recovery Current	$V_R=600\text{V}, I_F=600\text{A},$ $-di/dt=7040\text{A}/\mu\text{s}, V_{GE}=-8\text{V}$ $L_S=22\text{nH}, T_j=25^{\circ}\text{C}$		304		A
$E_{rec}$	Reverse Recovery Energy			10.8		mJ
$Q_r$	Recovered Charge			46.6		$\mu\text{C}$
$I_{RM}$	Peak Reverse Recovery Current	$V_R=600\text{V}, I_F=600\text{A},$ $-di/dt=5790\text{A}/\mu\text{s}, V_{GE}=-8\text{V}$ $L_S=22\text{nH}, T_j=150^{\circ}\text{C}$		336		A
$E_{rec}$	Reverse Recovery Energy			18.2		mJ
$Q_r$	Recovered Charge			49.8		$\mu\text{C}$
$I_{RM}$	Peak Reverse Recovery Current	$V_R=600\text{V}, I_F=600\text{A},$ $-di/dt=5520\text{A}/\mu\text{s}, V_{GE}=-8\text{V}$ $L_S=22\text{nH}, T_j=175^{\circ}\text{C}$		346		A
$E_{rec}$	Reverse Recovery Energy			19.8		mJ

### NTC Characteristics $T_f=25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$R_{25}$	Rated Resistance			5.0		k $\Omega$
$\Delta R/R$	Deviation of $R_{100}$	$T_C=100^{\circ}\text{C}, R_{100}=493.3\Omega$	-5		5	%
$P_{25}$	Power Dissipation				20.0	mW
$B_{25/50}$	B-value	$R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298.15\text{K}))]$		3375		K
$B_{25/80}$	B-value	$R_2=R_{25}\exp[B_{25/80}(1/T_2-1/(298.15\text{K}))]$		3411		K
$B_{25/100}$	B-value	$R_2=R_{25}\exp[B_{25/100}(1/T_2-1/(298.15\text{K}))]$		3433		K

**Module Characteristics**  $T_F=25^{\circ}\text{C}$  unless otherwise noted

Symbol	Parameter	Min.	Typ.	Max.	Unit
$L_{CE}$	Stray Inductance		8		nH
$R_{CC'+EE'}$	Module Lead Resistance, Terminal to Chip		0.75		m $\Omega$
p	Maximum Pressure In Cooling Circuit			2.5	bar
$R_{thJF}$	Junction-to-Cooling Fluid (per IGBT)		0.081	0.093	K/W
	Junction-to-Cooling Fluid (per Diode) $\Delta V/\Delta t=10.0\text{dm}^3/\text{min}, T_F=75^{\circ}\text{C}$		0.118	0.136	
M	Terminal Connection Torque, Screw M5	3.6		4.4	N.m
	Mounting Torque, Screw M4	1.8		2.2	
G	Weight of Module		750		g

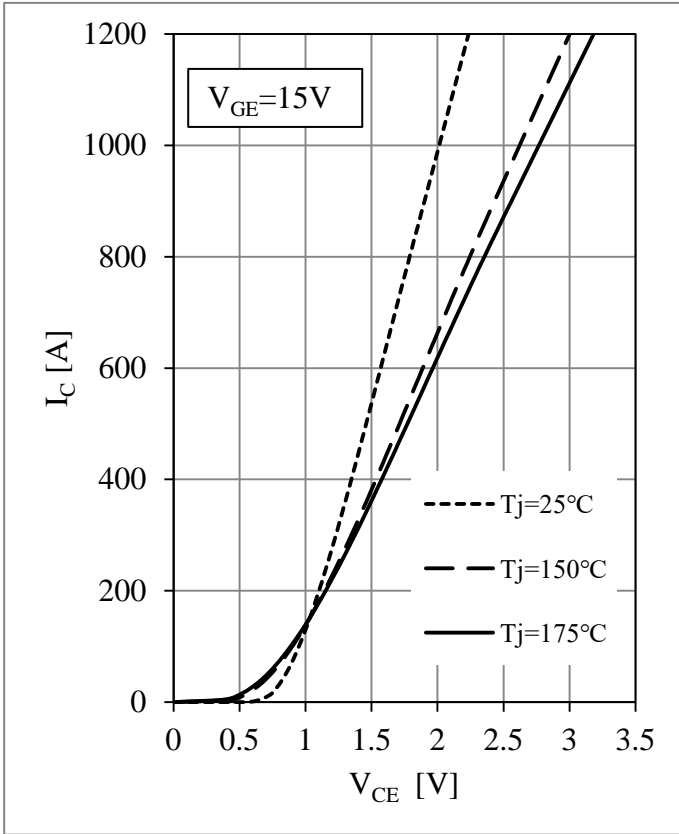


Fig 1. IGBT Output Characteristics

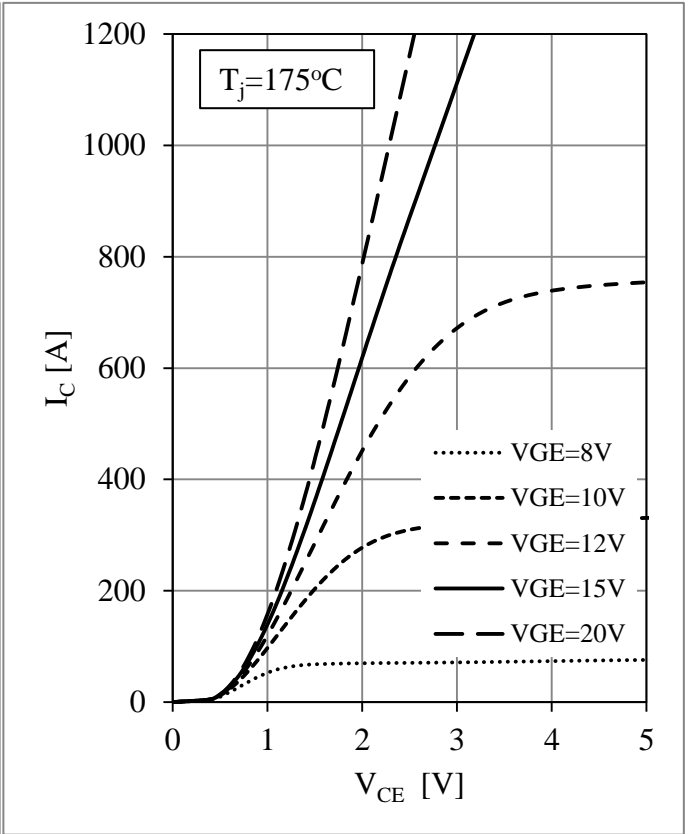


Fig 2. IGBT Output Characteristics

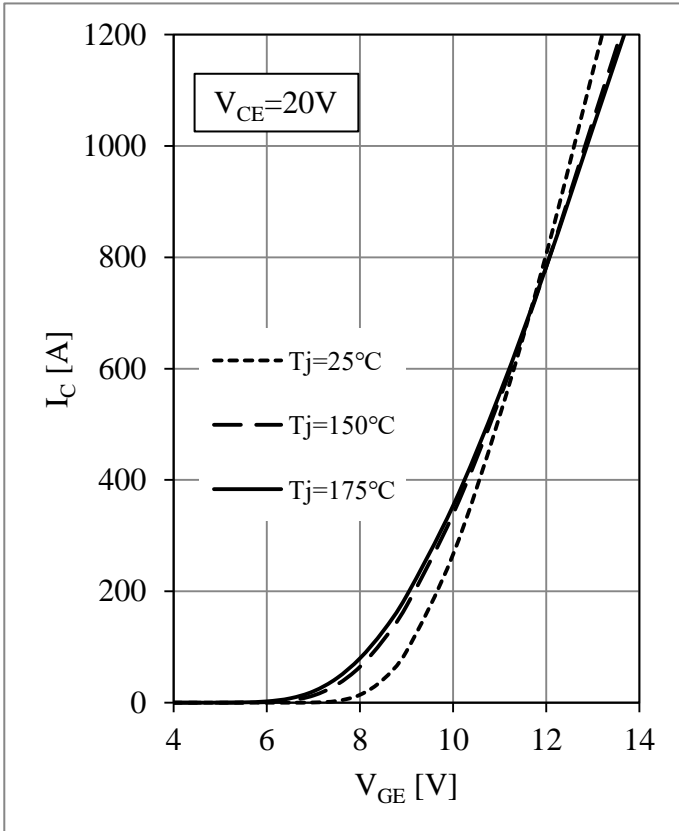


Fig 3. IGBT Transfer Characteristics

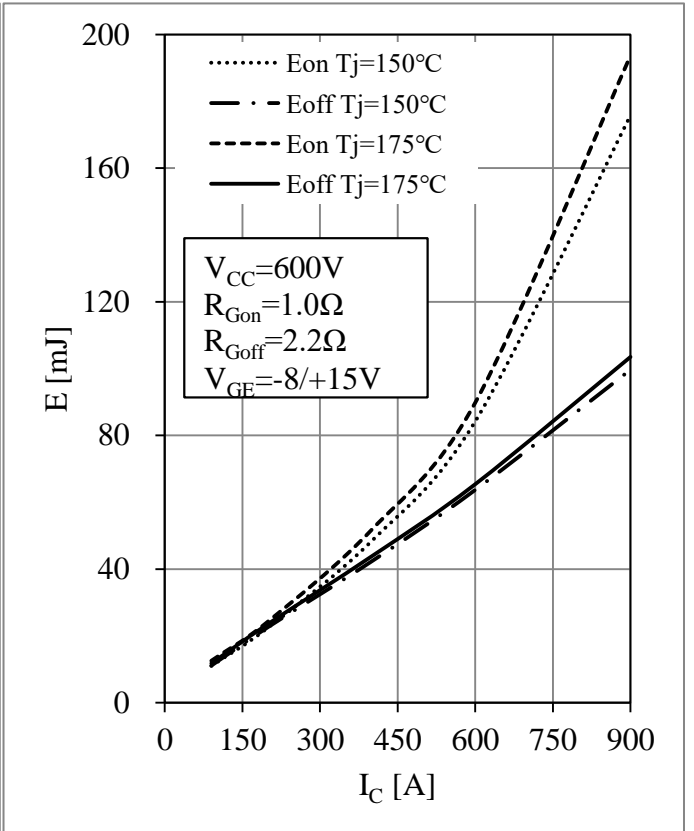


Fig 4. IGBT Switching Loss vs.  $I_C$

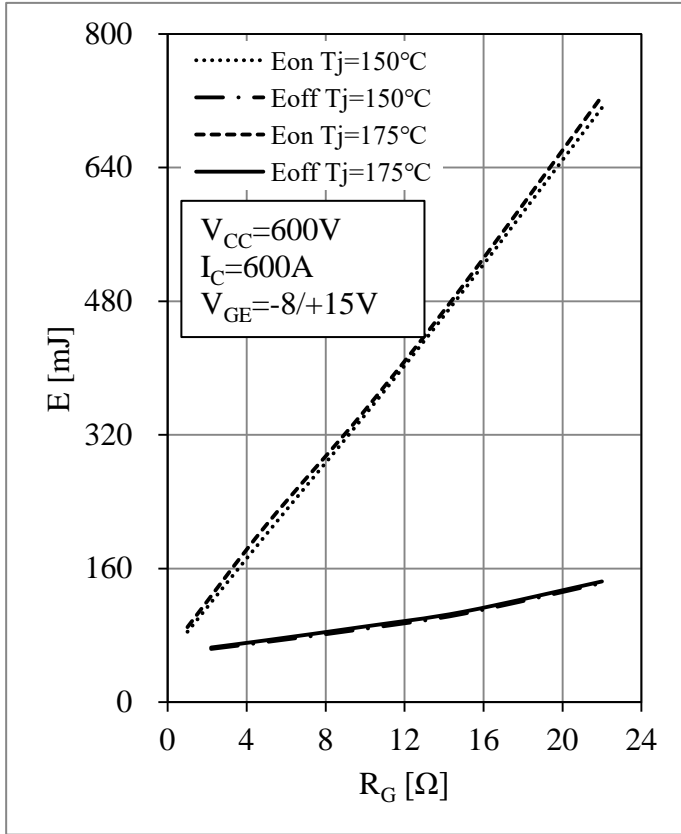


Fig 5. IGBT Switching Loss vs.  $R_G$

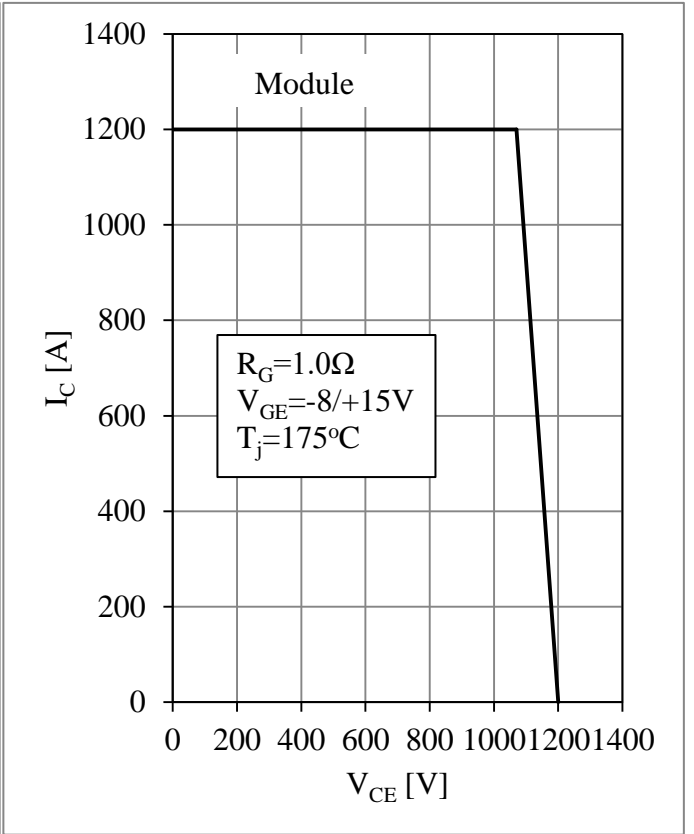


Fig 6. RBSOA

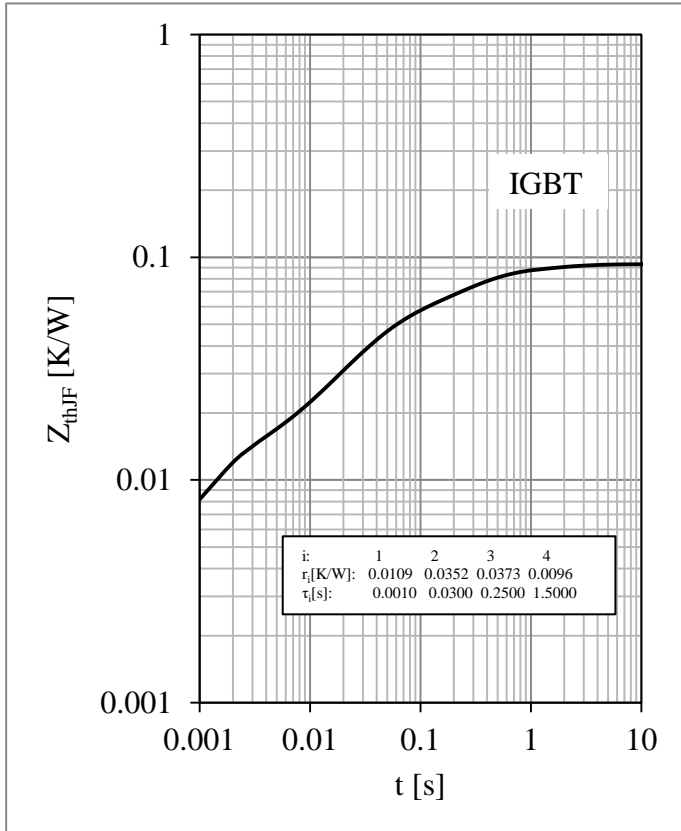


Fig 7. IGBT Transient Thermal Impedance

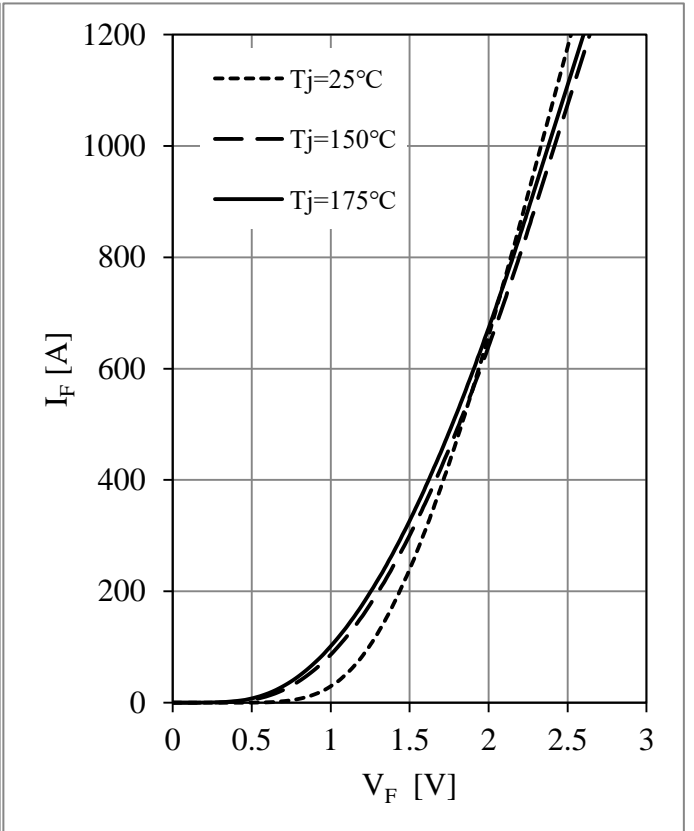


Fig 8. Diode Forward Characteristics

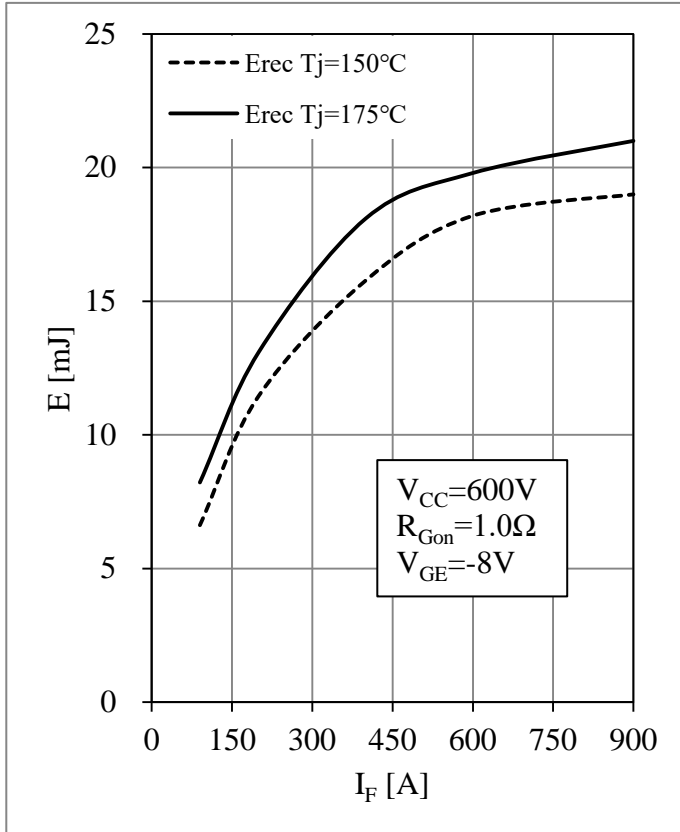


Fig 9. Diode Switching Loss vs.  $I_F$

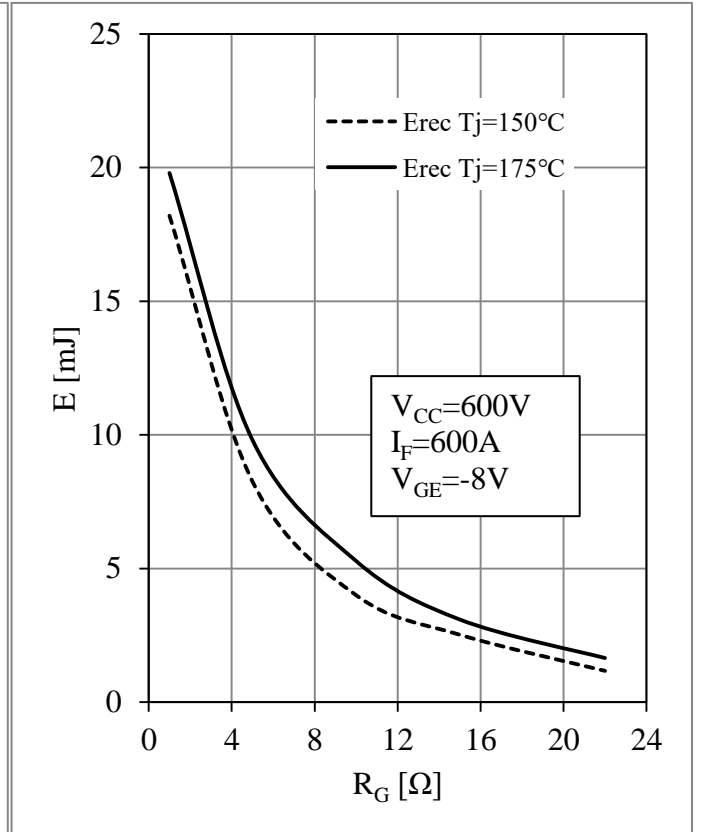


Fig 10. Diode Switching Loss vs.  $R_G$

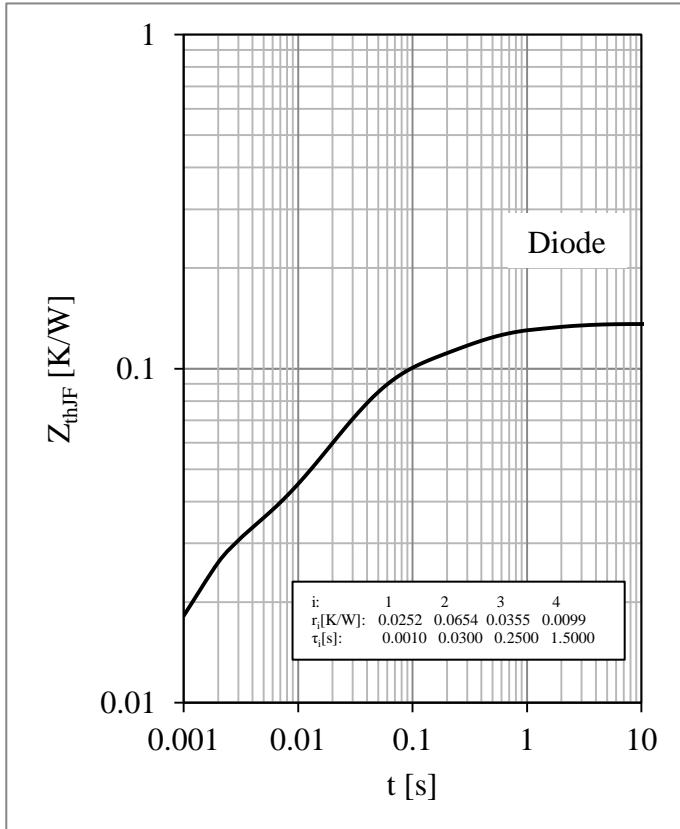


Fig 11. Diode Transient Thermal Impedance

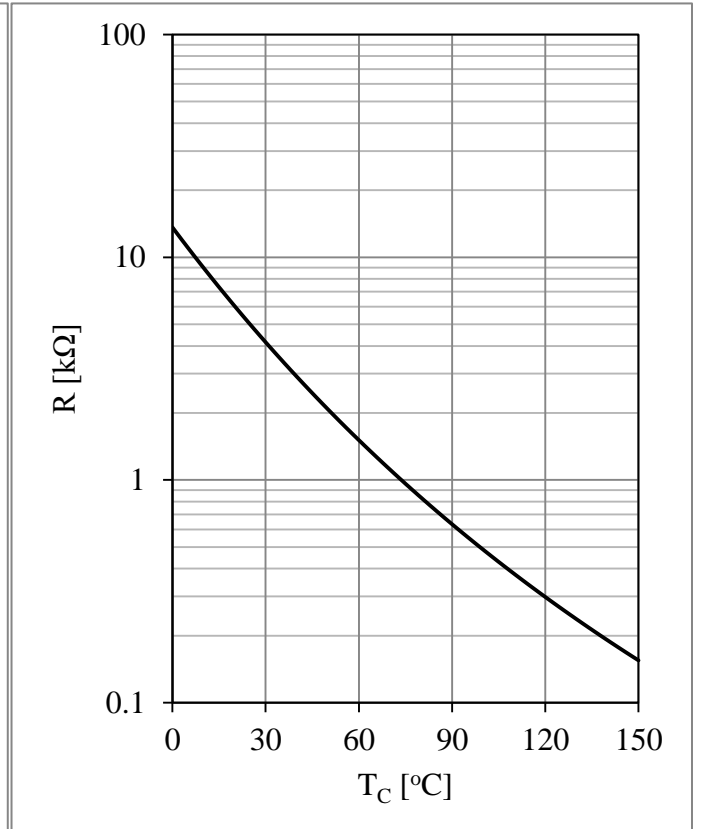


Fig 12. NTC Temperature Characteristic



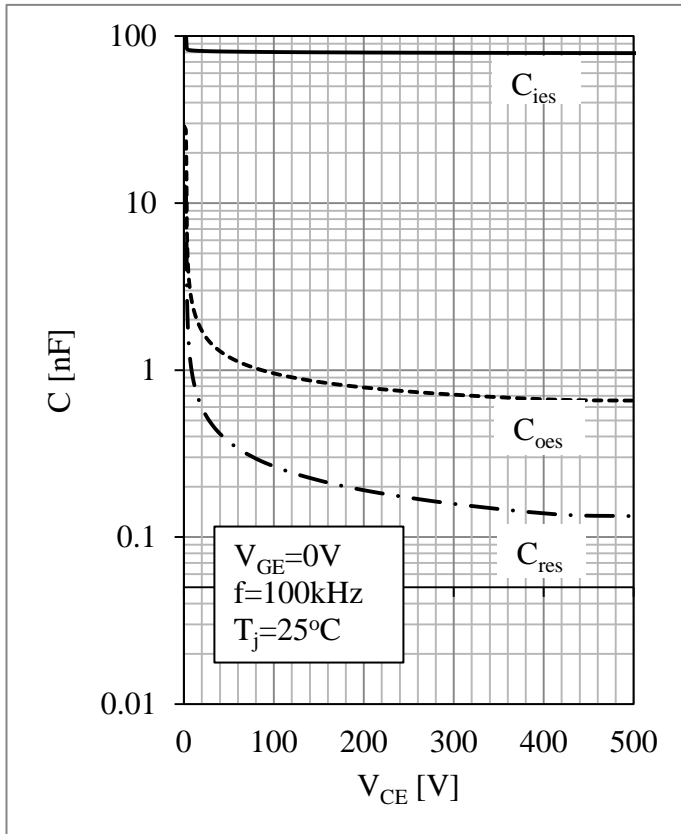
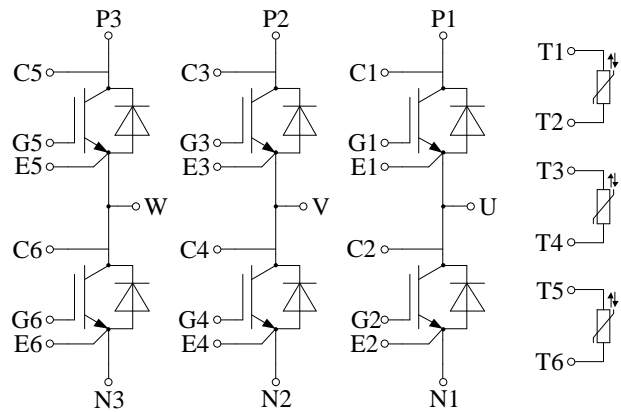


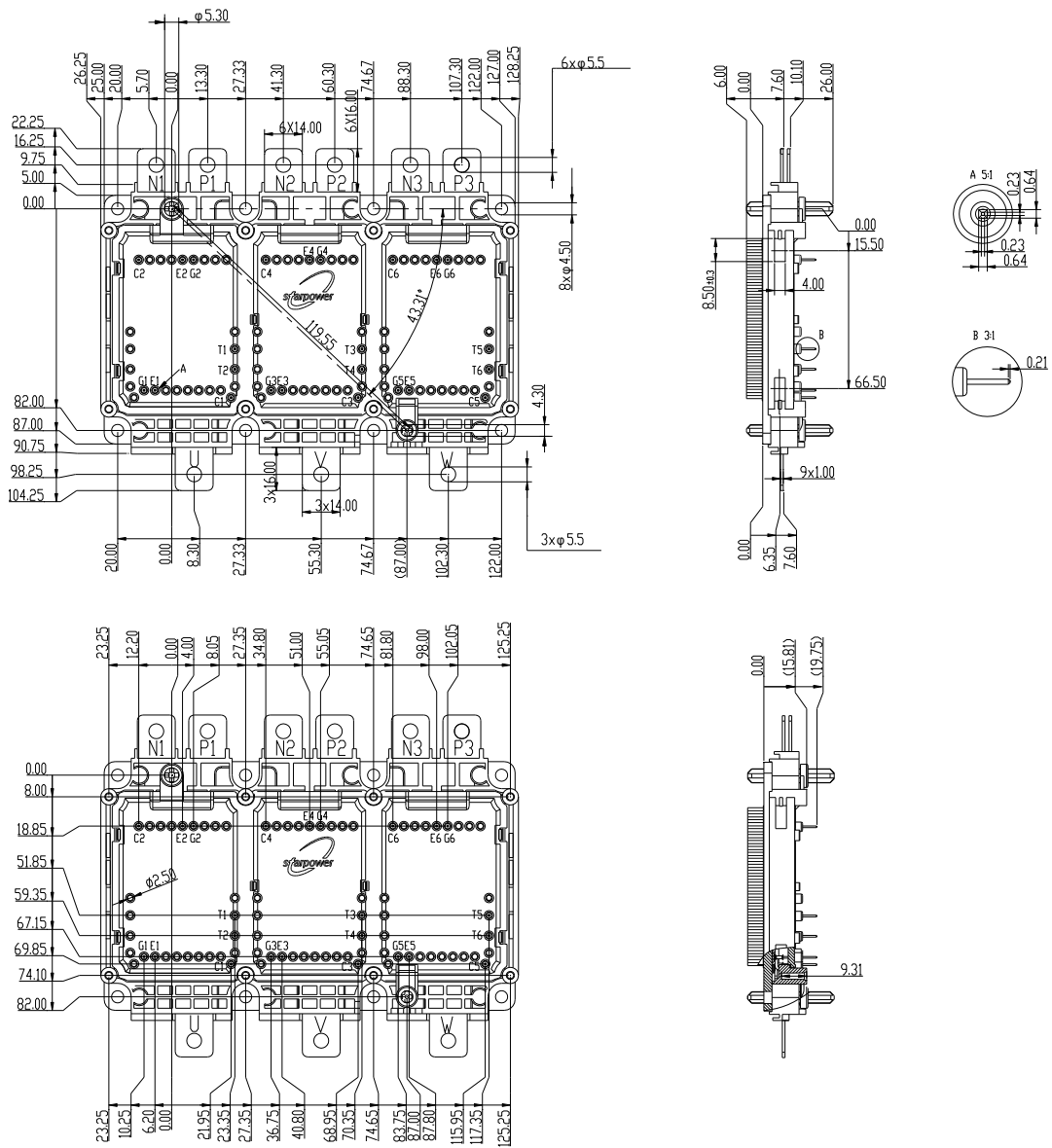
Fig 13. IGBT Capacity Characteristic

Circuit Schematic



Package Dimensions

Dimensions in Millimeters



## Terms and Conditions of Usage

The data contained in this product datasheet is exclusively intended for technically trained staff. you and your technical departments will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to such application.

This product data sheet is describing the characteristics of this product for which a warranty is granted. Any such warranty is granted exclusively pursuant the terms and conditions of the supply agreement. There will be no guarantee of any kind for the product and its characteristics.

Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of our product, please contact the sales office, which is responsible for you (see [www.powersemi.cc](http://www.powersemi.cc)), For those that are specifically interested we may provide application notes.

Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact the sales office, which is responsible for you.

Should you intend to use the Product in aviation applications, in health or live endangering or life support applications, please notify.

If and to the extent necessary, please forward equivalent notices to your customers.  
Changes of this product data sheet are reserved.